

# SILICON TRANSISTOR 2SC4095

## MICROWAVE LOW NOISE AMPLIFIER NPN SILICON EPITAXIAL TRANSISTOR 4 PINS MINI MOLD

## **DESCRIPTION**

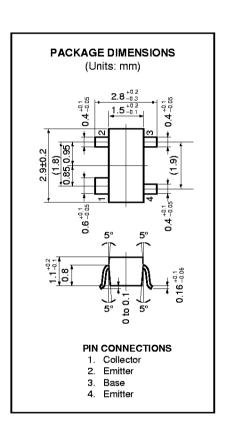
The 2SC4095 is an NPN epitaxial silicon transistor designed for use in low-noise and small signal amplifiers from VHF band to UHF band. 2SC4095 features excellent power gain with very low-noise figures. 2SC4095 employs direct nitiride passivated base surface process (DNP process) which is an NEC proprietary new fabrication technique which provides excellent noise figures at high current values. This allows excellent associated gain and very wide dynamic range.

#### **FEATURES**

- NF = 1.8 dB TYP. @ f = 2.0 GHz, VcE = 6 V, Ic = 5 mA
- |S<sub>21e</sub>|<sup>2</sup> = 9.5 dB TYP. @ f = 2.0 GHz, VcE = 6 V, lc = 10 mA

## ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

| Collector to Base Voltage    | VcBo | 20          | V  |
|------------------------------|------|-------------|----|
| Collector to Emitter Voltage | VCEO | 10          | V  |
| Emitter to Base Voltage      | VEBO | 1.5         | V  |
| Collector Current            | lc   | 35          | mΑ |
| Total Power Dissipation      | PT   | 200         | mW |
| Junction Temperature         | Tj   | 150         | °C |
| Storage Temperature          | Tstg | -65 to +150 | °C |



## ELECTRICAL CHARACTERISTICS (TA = 25 °C)

| CHARACTERISTIC           | SYMBOL                          | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS                    |
|--------------------------|---------------------------------|------|------|------|------|------------------------------------|
| Collector Cutoff Current | Ісво                            |      |      | 1.0  | μA   | VcB = 10 V, IE = 0                 |
| Emitter Cutoff Current   | Ієво                            |      |      | 1.0  | μΑ   | V <sub>EB</sub> = 1 V, Ic = 0      |
| DC Current Gain          | h⊧∈                             | 50   | 100  | 250  |      | VcE = 6 V, lc = 10 mA              |
| Gain Bandwidth Product   | f⊤                              |      | 10   |      | GHz  | VcE = 6 V, lc = 10 mA f = 1.0 GHz  |
| Feed-Back Capacitance    | C <sub>re</sub>                 |      | 0.25 | 0.8  | pF   | VcB = 10 V, IE = 0, f = 1.0 MHz    |
| Insertion Power Gain     | S <sub>21e</sub>   <sup>2</sup> | 7.5  | 9.5  |      | dB   | VcE = 6 V, lc = 10 mA, f = 2.0 GHz |
| Maximum Available Gain   | MAG                             |      | 12   |      | dB   | Vce = 6 V, lc = 10 mA, f = 2.0 GHz |
| Noise Figure             | NF                              |      | 1.8  | 3.0  | dB   | VcE = 6 V, lc = 5 mA, f = 2.0 GHz  |

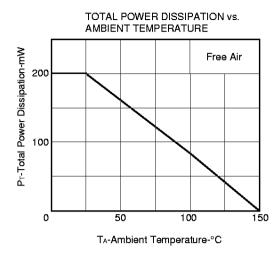
## hee Classification

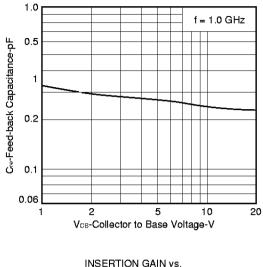
| Class   | R46/RDF * | R47/RDG * | R48/RDH *  |
|---------|-----------|-----------|------------|
| Marking | R46       | R47       | R48        |
| h⊧∈     | 50 to 100 | 80 to 160 | 125 to 250 |

<sup>\*</sup> Old Specification / New Specification



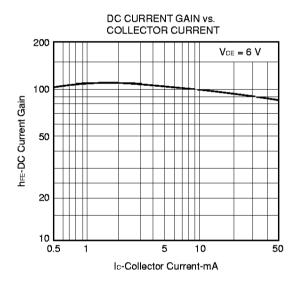
## TYPICAL CHARACTERISTICS (TA = 25 °C)

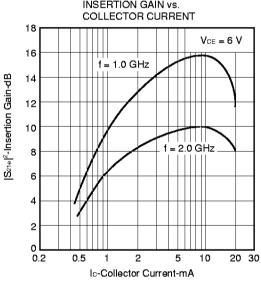


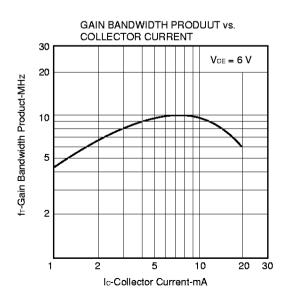


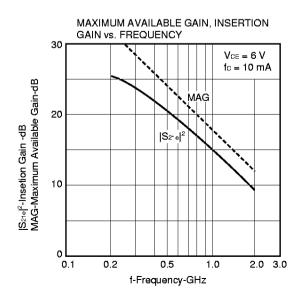
FEED-BACK CAPACITANCE vs.

COLLECTOR TO BASE VOLTAGE

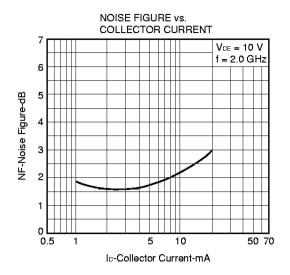












## S-PARAMETER

1400

1600

1800

2000

0.131

0.132

0.150

0.163

-163.0

179.6

160.0

150.1

4.597

3.927

3.743

3.233

 $V_{CE} = 6.0 \text{ V}, \text{ lc} = 3.0 \text{ mA}, \text{ Zo} = 50 \Omega$ 

| VCE = 6.0  | $V_1 = 3.0 \text{ m}$ | $A, ZO = 50 \Omega$ |                 |               |                 |               |                 |               |
|------------|-----------------------|---------------------|-----------------|---------------|-----------------|---------------|-----------------|---------------|
| f (MHz)    | S11                   | ∠ <b>S</b> 11       | S <sub>21</sub> | ∠ <b>S</b> 21 | S <sub>12</sub> | ∠ <b>S</b> 12 | S22             | ∠ <b>S</b> 22 |
| 200        | 0.870                 | -24.2               | 9.193           | 155.6         | 0.031           | 53.6          | 0.946           | -12.8         |
| 400        | 0.747                 | -44.6               | 7.780           | 136.6         | 0.040           | 66.2          | 0.876           | -20.7         |
| 600        | 0.628                 | -59.8               | 7.058           | 122.1         | 0.064           | 54.7          | 0.816           | -26.4         |
| 800        | 0.516                 | -75.1               | 5.675           | 109.4         | 0.066           | 56.0          | 0.743           | -30.9         |
| 1000       | 0.400                 | -87.7               | 5.180           | 99.6          | 0.090           | 49.4          | 0.689           | -33.0         |
| 1200       | 0.327                 | -103.4              | 4.269           | 89.8          | 0.084           | 47.9          | 0.654           | -35.7         |
| 1400       | 0.262                 | -118.7              | 3.950           | 81.7          | 0.106           | 48.5          | 0.604           | -37.7         |
| 1600       | 0.231                 | -135.5              | 3.406           | 74.0          | 0.105           | 42.1          | 0.581           | -41.5         |
| 1800       | 0.205                 | -155.3              | 3.290           | 66.4          | 0.126           | 46.4          | 0.548           | -43.9         |
| 2000       | 0.196                 | -170.6              | 2.867           | 60.8          | 0.124           | 40.9          | 0.529           | -47.1         |
|            |                       |                     |                 |               |                 |               |                 |               |
| VCE 6.0 V, | Ic = 10.0  m/s        | $A, Zo = 50 \Omega$ |                 |               |                 |               |                 |               |
| f (MHz)    | S <sub>11</sub>       | ∠ <b>S</b> 11       | S <sub>21</sub> | ∠ <b>S</b> 21 | S <sub>12</sub> | ∠ <b>S</b> 12 | S <sub>22</sub> | ∠ <b>S</b> 22 |
| 200        | 0.671                 | -43.5               | 18.685          | 137.9         | 0.023           | 52.1          | 0.832           | -19.0         |
| 400        | 0.458                 | -68.7               | 12.702          | 115.2         | 0.029           | 62.2          | 0.710           | -23.9         |
| 600        | 0.319                 | -83.7               | 9.895           | 102.8         | 0.046           | 54.4          | 0.649           | -26.0         |
| 800        | .0239                 | -101.9              | 7.275           | 92.3          | 0.049           | 63.1          | 0.600           | -27.5         |
| 1000       | 0.172                 | -119.3              | 6.261           | 85.1          | 0.067           | 58.6          | 0.578           | -28.4         |
| 1200       | 0.149                 | -141.4              | 5.038           | 77.4          | 0.070           | 57.9          | 0.559           | -30.3         |
|            |                       |                     |                 |               |                 |               |                 |               |

71.0

64.8

58.8

54.5

0.088

0.094

0.113

0.115

56.1

54.0

55.3

50.0

0.527

0.514

0.494

0.478

3

-32.5

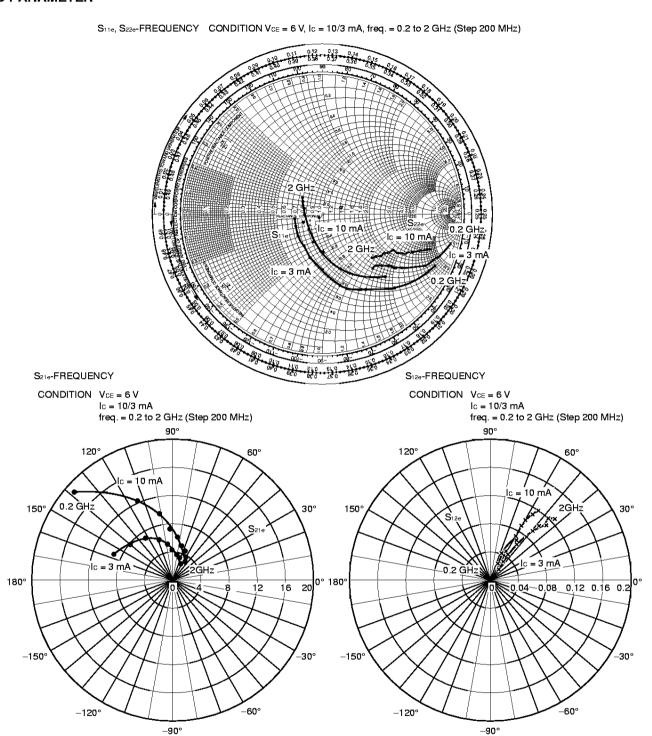
-35.7

-38.1

-41.6



## S-PARAMETER





## RECOMMENDED SOLDERING CONDTITIONS

The following conditions (see table below) must be met then soldering this product. Please consult with our sales offices in case other soldering process is used, or in case soldering is done under different contions.

## TYPES OF SURFACE MOUNT DEVICE

For more details, refer to our document "SMT MANUAL" (IEI-1207).

## 2SC4095

| Soldering process      |   | Symbol  |           |
|------------------------|---|---|-----------|
| Infrared ray reflow    | Peak package's surface tem<br>Reflow time:<br>Number of reflow process: | IR30-00-1   |           |
| VPS                    | Peak package's surface tem<br>Reflow time:<br>Number of reflow process: | perature: 215 °C or below,<br>40 seconds or below (200 °C or higher),<br>1, Exposure limit*: None | VP15-00-1 |
| Wave soldering         | Solder temperature: Flow time: Number of reflow process:                | 260 °C or below,<br>10 seconds or below,<br>1, Exposure limit*: None                              | WS60-00-1 |
| Partial heating method | Terminal temperature: Flow time: Exposure limit*:                       | 300 °C or below,<br>3 seconds or below,<br>None   | 0         |

<sup>\*:</sup> Exposure limit before soldering after dry-pack package is opened.

Storage conditions: 25 °C and relative humidity at 65 % or less.

Note: Do not apply more than a single process at once, except for "Partial heating method".

5

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for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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Anti-radioactive design is not implemented in this product.

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